# Beverly Display Solutions

Module No.: BD084QCS01

Revision: Ver 1.0

# Customer

Date	Notes
	Date

2200.20001

	Rev	Issued Date	Description	Editor
	1.0	2013-1-2	Preliminary Specification Release	
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## 1. General Description

• 8.4", Normally Black with Auti-Glare, MVA TFT dot matrix LCD module.

Viewing Angle: 12 o'clock
Logic Voltage: 3.3V(Type)
Data Interface: RGB Interface.

# 2. Mechanical Specifications

The mechanical detail is shown in Fig. 2 and summarized in Table 1 below.

Table 1

Parameter		Specifications	Unit
Outline dimensions		200.0(W) x 152.0(H) x 10.5(D)	mm
	Active area	170.88(W) x 128.16(H)	mm
Color TFT	Display format	640 (RGB) x 480	dots
240xRGBx320	Color configuration	RGB stripe	-
	Dot pitch	0.267 (RGB) (W) x 0.267(H)	mm
Weight		Approx 330	gram

Note 1: Viewing direction for best image quality is different from TFT definition. There is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

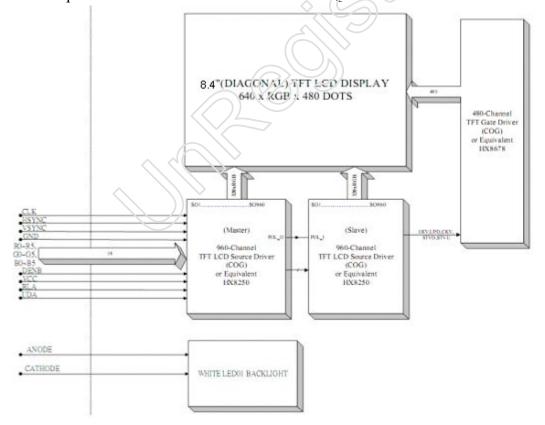
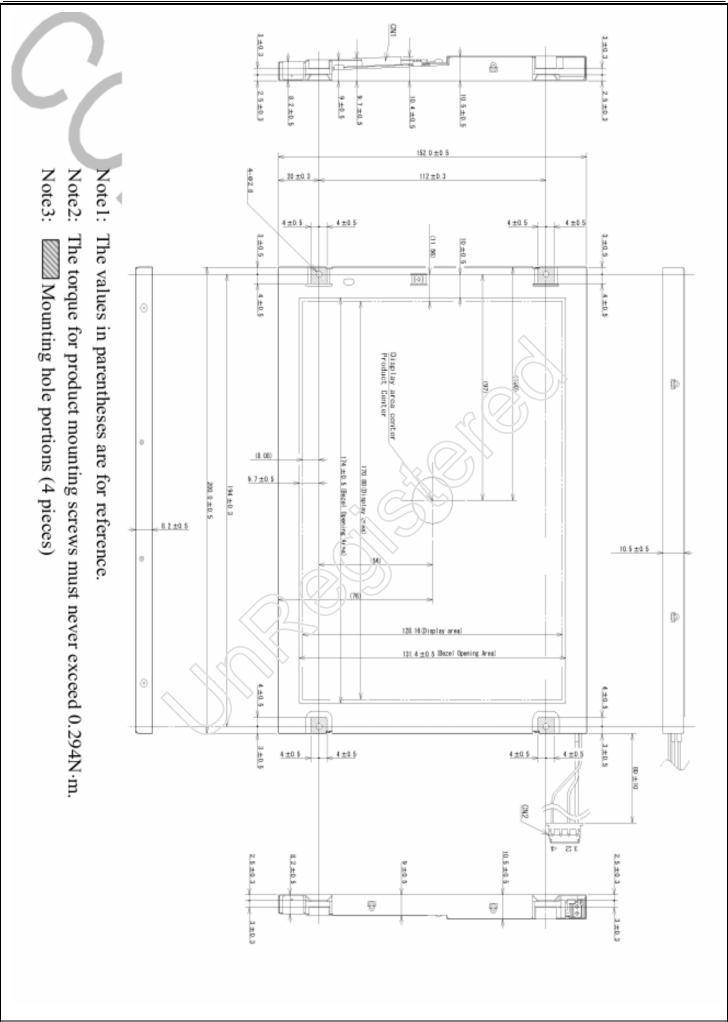


Figure 1: Block Diagram





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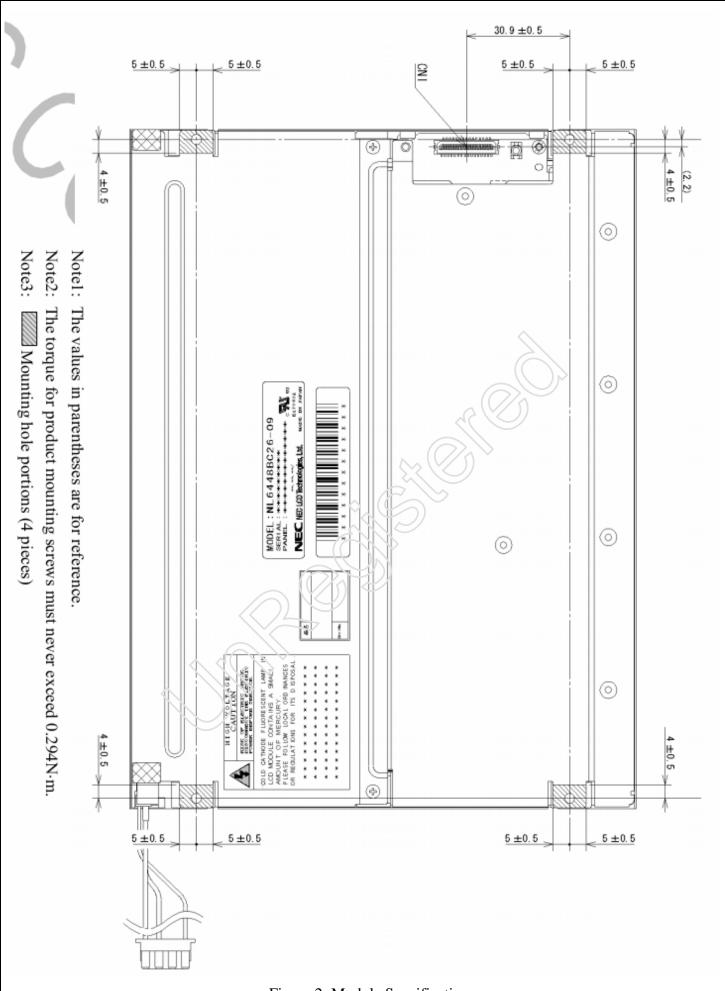


Figure 2: Module Specification

# 3. Interface Signals

<u>Table 2: Pin assignment</u>

Pin No.	Symbol	Description
1	GND	Ground.
2	DCLK	Dot Data Clock
3	HSYNC	Horizontal Synchronous Signal
4	VSYNC	Vertical Synchronous Signal
5	GND	Ground.
6~11	R0~R5	Red Data bus.
12	GND	Ground.
13~18	G0~G5	Green Data bus.
19	GND	Ground.
20~25	B0~B5	Blue Data bus.
26	GND	Ground.
27	DEN	Data Enable Signal
28,29	VDD	Power supply to the liquid crystal power supply analog circuit.  Connect to an external power supply.
30	NC	Dummy pin, please let it float.
31	DPS	Set scan direction. High: Reverse scan; Low: Normal scan.

## Attention: VBLH and VBLC must be connected correctly. Wrong conNLTtions will cause electric shock and also break down of the product.

Adaptable socket:

CN2 plug (LCD module side): BHR-04VS-1 (J.S.T Mfg. Co., Ltd.) SM03 (7-D1) B-BHS-1-TB (LF)(SN),

SM03 (7-D1) B-BHS-1-TB (J.S.T Mfg. Co., Ltd.)

Pin No.	Symbol	Signal	Remarks
1	VBLH	High voltage (Hot)	Cable color: Pink
2	VBLH	High voltage (Hot)	Cable color: Pink
3	N. C.	-	Keep this pin Open.
4	VBLC	Low voltage (Cold)	Cable color: Black

# 4. Absolute Maximum Ratings

# **4.1 Electrical Maximum Ratings – for IC Only**

Table 3

Parameter	Symbol	Min.	Max.	Unit
Power supply voltage (VDD)	IOVDD	-0.3	+5.0	V
Power supply voltage (VDD)	VDD	-0.3	+5.0	V
Back Light Forward Current	IF		75	mA
Logic input voltage	VIN	-0.3	IOVDD+0.5	V
Logic output voltage	VOUT	-0.3	IOVDD+0.5	V

Note 1: GND = 0V.

Note2: No condensation allowed under any condition.

## **4.2 Environmental Condition**

Table 4

Itom	Opera	_	Storage temp		Remark	
Item	Min.	re (Topr) Max.	(Tstg) (Note 1) Min. Max.		Remark	
Ambient temperature(Ta)	-20°C	+70°C	-30°C	+85°C	Dry	
Timotoni temperature(1a)	90% max.	170 C	30 6	103 C	Diy	
	RH for Ta			40		
		C< 50%			37 1	
Humidity (Note 1)	RH for 40		C <	< Ta	No condensation	
	operating te					
Vibration(IEC 68-2-6)	Frequency:	10		55 Hz		
cells must be mounted	1 1111 p 113 dr Cr	0.75 mm I	Ouration: 20	cycles in each	3 directions	
on a suitable connector	direction.					
	Pulse di					
Shock (IEC 68-2-27) Half	Peak ac	g	3 directions			
-sine pulse shape	Number of shocks: 3 shocks in 3 mutually				3 directions	
	perpendicul	ar axes.				

Note 1: Product cannot sustain at extreme storage conditions for long time.

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# **5. Electrical Specifications**

## **5.1** Typical Electrical Characteristics

At Ta = 25 °C, VDD=5.0V, GND=0V.

Table 5

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply voltage	VDD		+3.0	+5.0	+5.5	V
Gate drive High voltage	VGH		-	-	-	V
Gate drive Low voltage	VGL		-	-	-	V
T 1 1	$V_{\mathrm{IH}}$	"H" level	0.7IOV DD	-	IOVD D	V
Input signal voltage	$V_{IL}$	"L" level	VSSD	-	0.3IOV DD	V
Supply current	ICC+IVDD	IOVDD= +3.3V, Note1	-		-	mA
Suppry current	ICC+I V DD	VDD = +3.3V, Note 1		-	-	mA
Supply voltage of white LED backlight	Supply voltage of white VLED		19.95	-	25.9	V

Note 1: Do not display the fixed pattern for a long time because it may develop image sticking due to the LCD structure. It should change pattern frequently. If the screen is displayed with fixed pattern, use a screen saver.

# **5.2 TFT Panel Timing Characteristics**

## **5.2.1** Input Setup Timing

At Ta = 25°C, GND=0V, IOVDD=VDD=3.3V.

Table 6

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
DOTCLK pulse duty	Tcwh	40%	50%	60%	Tclk	Tcph is DCLK cycle
VSYNC setup time	Tvst	10	-	-	ns	
VSYNC hold time	Tvhd	10		Œ	ns	
HSYNC setup time	Thst	10	-	: <del>-</del>	ns	
HSYNC hold time	Thhd	10	- 1		ns	
Data setup time	Tdsu	10	- 1	-	ns	Rn, Gn, Bn to DCLK
Data hold time	Tdhd	10	- 1	4	ns	Rn, Gn, Bn to DCLK
Enable setup time	Tesu	10			ns	9

Table 5.4 AC input characteristics

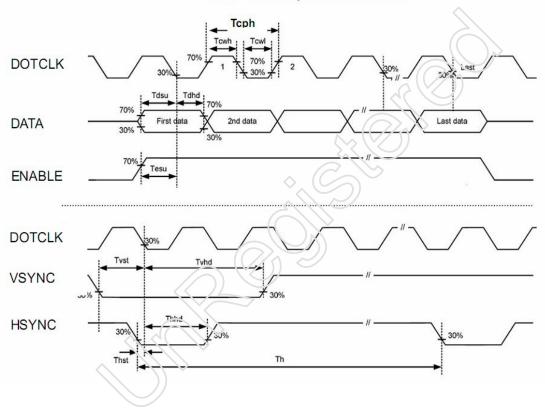


Figure 1: Input Setup Timing

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## **5.2.2 Data Input Timing Parameter Setting**

At Ta = 25°C, GND=0V, VDD=3.3V.

Table 7

Parameter	Symbol	Symbol	Min	Тур	Max	Unit
CK	Dotclk frequency	Fclk	24.8	25.2	34.2	MHz
CK	Dotclk cycle	Tclk	29.24	39.68	40.32	ns
	Horizontal display area	Thd	640	640	640	Tclk
	1 horizontal line	Th	800	800	1000	Tclk
Hsync	Hsync pulse width	Thpw	1	-	1	Tclk
	Horizontal blank	Thb	144	144	144	Tclk
	Horizontal front porch	Thfp	16	16	216	Tclk
	Frame rate	n=		60	- 1	Hz
	Vertical display area	Tvd	480	480	480	Th
Mayraa	Vsync period time	Tv	516	525	570	Th
Vsync	Vsync pulse width	Tvpw	1	-	<u> </u>	Th
	Vsync blank	Tvb	35	35	35	Th
	Vsync front porch	Tvfp	1	10	55	Th

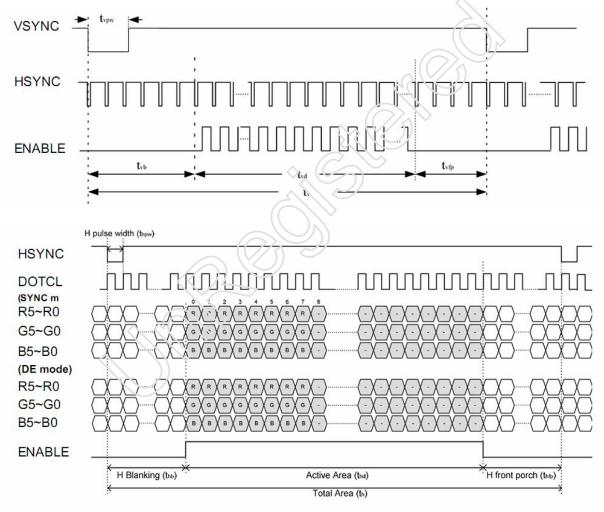
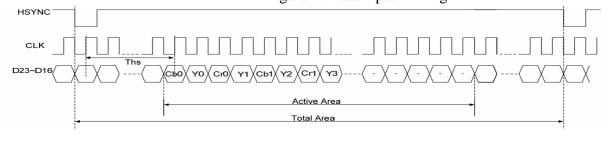


Figure 2: Data Input Timing



#### Figure 3: DE Mode Interface Characteristics

## **6. Optical Characteristics (for panel only)**

Table 8: Optical characteristics

Items		Symbol	Cond	ition	Min.	Typ.	Max.	Unit	Note
Response Ti	ime	$T_R + T_F$	Ta=25°C	Viewing normal angle $\theta = \phi = 0^{\circ}$	-	20	30	ms	(Note 1)
	12'	2			ı	70	1		
Viewing angle	6'	1	Ta=25°C	Center	-	60	-	deg.	(Note 2)
viewing angle	9'	2	1a-25 C	CR≥10	-	70	-	ucg.	(Note 2)
	3'	1			-	70	1		
Contrast Ratio		CR	Ta=25°C	Viewing normal angle $\theta = \phi = 0^{\circ}$	300	600	-	-	(Note 3)
Luminance (on the surface)	e module	Br	Ta=25°C		300	450		cd/m <sup>2</sup>	
Transmittance		%			-	6.5		%	
	Red	$x_R$				0.616		-	
	Red	$y_R$				0.353		-	
	Green	$x_G$		Viewing		0.335		-	
Chromaticity	Giccii	$y_{G}$	Ta=25°C	normal		0.576		-	(Note 4)
Cinomaticity	Blue	$x_{B}$	1 a – 25 C	angle	3/10	0.136			
	Diac	$y_B$		$\theta = \phi = 0^{\circ}$		0.126		-	
	White	$x_{W}$			<u>D)</u>	0.324		-	
	, , 11110	Уw		7///0		0.362		-	

Note 1: The electro-optical response time measurements shall be made as Figure 5 by switching the "data" input signal OFF and ON. The times needed for the luminance to change from 10% to 90% s  $T_r$ , and 90% to 10% is  $T_f$ .

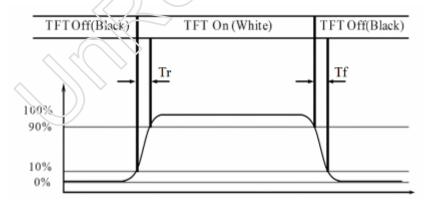


Figure 5: Response Time Testing

Note 2: The definitions of viewing angle.

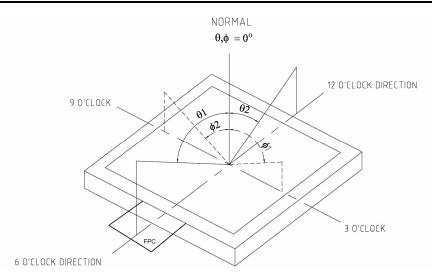


Figure 6

Note 3:Contrast measurements shall be made at viewing angle of  $\theta$ =0° and at the center of the LCD surface by using DMS. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state. (See figure 6)

Luminace Contrast Ratio (CR) is defined mathematically.

 $CR = \frac{Luminance when displaying a white raster}{Luminance when displaying a black raster}$ 

Note 4: The color chromaticity coordinates specified in Table 9 shall be updated from later actual spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the panel.

# **7. TFT Panel Inspection Specifications**

Failure mode	Illustration	Category(Unit: mm)		Acceptable count			
Tunure mode	mustration			Viewing area	non-Viewing area		
	<b>♦</b> ₩idth	A	Φ ≦ 0. 10	Not count			
Black spot White spot	Length	В	B 0.10<Φ≤0.15 betw spot 5 mm		Not count		
		С	0. 15<Φ ≤ 0. 20	1			
	$\Phi = (\text{Length+width})/2$	D	0. 20<Ф	0			
Bright spot(Red spot,green spot and blue spot caused by damaged colour filter)		A	Area≦1 sub-pixel	1	N/A		
	. W	A	W≦0.03	Not count	Not count		
Black line	$\bigvee$ W	В	$0.03 \le 0.05, L \le 3.0$	2			
White line	L L	С	9. 05 <w< td=""><td>Judged by spot</td><td></td></w<>	Judged by spot			
Below are cosn	netic inspection specifications	process (Reddimension of	s defect shall not affect marks: For COG process of LCD panel.)	, the defect size is	decided by t		
The depth of UV glue entered in LCD cell	a. $D1 \ge 0.2$ , not enter into viewing area b. $D2 \le 0.8$ , c. W=End mouth width + (2~6 mm)						

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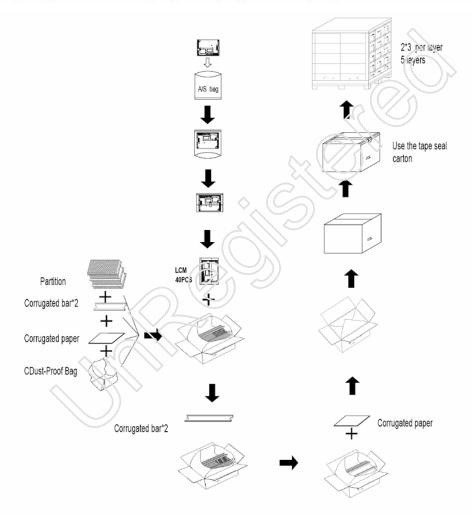
<u>-</u>	① LCD ledge damage	Category		
	b b	A	The defect shall not affect the outline dimension o assembly process at non ITO zone.	
	w t a c	В	$b \le 1/4$ w, a & c not count (at ITO zone)	
		С	Alignment mark on LCD ledge shall not be damaged.	
Glass defect(scratch ,damage)	② Outside of perimeter damage 边框架(Perimeter) 边框外沿(Inside of perimeter) 边框外沿(outside of perimeter)	b can't reach inside of perimeter.		
	③ Joint glass damage 边框架(Perimeter) 边框内沿(Inside of perimeter) 边框外沿(Outside of perimeter)	b can't reach outside of perimeter or ITO layout.		
	4 Corner damage	B. Alignment m	$a \le t$ , $b \le 3.0$ , $c \le 3.0$ mark on LCD ledge shall not be damaged.	

# 8. Packing demonstrate

No	Item	Model(Material)	Dimensions (mm)	Unit Weigt (Kg)	Quantity	Remark
1	LCM module	BD057QDB01	144X104.6X12.3	TBD	40	
2	Partition_1	Corrugated paper	513X333X215	1.388	1	
3	Anti-static Bag	PE	180X165X0.05	0.001	40	Anti-static
4	Dust-Proof Bag	PE	700X530	0.06	1	
5	Partition_2	Corrugated Paper	505X332X4.0	0.098	2	
6	Corrugated Bar	Corrugated paper	513X110×31	0.048	4	
7	Carton	Corrugated paper	530X350X250	1.12	1	
8	Total weight	veight TBD				

Note: Packaging Specification and Quantity

Module quantity in a carton: 20pcs(per row)x2(per column)= 40pcs



#### 9. PRECAUTIONS FOR LCM

Beverly Display Solutions LCMs have been assembled and accurately calibrated before delivery. Please observe the following criteria when handling.

#### 9.1 Static electricity warning

A. Do not take the LCM from its anti-static bag until it's to be assembled.

LCM's are individually packaged in bags specially treated to resist static electricity. When storing, keep the LCM packed in the original bags, or store them in a container processed to be resistant to static electricity, or in an electric conductive container.

B. Always use a ground strap when handling a LCM.

Always use a ground strap while working with the module, from the time it is taken out of the anti-static bag until it is assembled. If it is necessary to transfer the LCM, once it has been taken out of the bag, always place it in an electric conductive container. Avoid wearing clothes made of chemical fibers, the use of cotton or conductive treated fiber clothing is recommended.

C. Use a no-leak iron for soldering the LCM.

The soldering iron to be used for soldering the I/O terminals to the LCM are to be insulated or grounded at the iron tip.

D. Always ground electrical apparatuses required for assembly.

Electrical apparatuses required to assemble the LCM into a product, i.e. electrical screw drivers, are to be first grounded to avoid transmitting spike noises from the motor.

- E. Assure that the work bench is properly grounded.
- F. Peel off the LCM protective film slowly.

The module is attached with a film to protect the display surface from contamination, damage, adhesion of flux, etc. Peeling off this film abruptly could cause static electricity to be generated, so peel the tape slowly.

G. Pay attention to the humidity in the work area.

50~60% RH is recommended.

#### 9.2 Precautions for the soldering of a LCM

The following procedures should be followed when soldering the LCM:

- A. Solder only to the I/O terminal.
- B. Use a no leakage soldering iron and pay particular attention to the following:
  - (1) Conditions for soldering I/O terminals

Temperature at iron tip:  $280^{\circ}\text{C} + 10^{\circ}\text{C}$ 

Soldering time: 3~4 sec/terminal

Type of solder: Eutectic solder (rosin flux filled)

Note: (Avoid using flux, because it could penetrate the module and the module may get contaminated during cleaning.) Peel off protective film after soldering the I/O terminals. By following this procedure, the surface contamination caused by the dispersion of flux while soldering can be avoided.

#### (2) Removing the wiring

(When a lead wire, or a connector to the I/O terminal of the module is to be removed, remove it only after the solder at the connection has sufficiently melted since the I/O terminal is a through hole.) If it is forcefully removed, it could cause the terminal to break or peel. The recommended procedure is to use a suction-type solder remover. Caution: do not reheat the I/O terminal more than 3 times.

### 9.3 Long-term storage

If the correct method of storage is not followed, deterioration of the display material (polarizer) and oxidation of the I/O terminal plating may make the process of soldering difficult. Please comply with the following procedure.

- A. Store in the shipping container.
- B. If the shipping container is not available, place in anti-static bags and seal the opening.
- C. Store the modules where they are not subjected to direct sunlight or a fluorescent lamp.
- D. Store in a temperature range of  $0^{\circ}$ C 35  $^{\circ}$ C with low relative humidity.

#### 9.4 Precautions in use of LCD modules

- A. Do not give any external shock.
- B. Do not wipe the surface with hard materials.
- C. Do not apply excessive force on the surface.
- D. Do not expose to direct sunlight or fluorescent light for a long time.
- E. Avoid storage in high temperature and high humidity.
- F. When storage for a long time at  $40^{\circ}$ C or higher is required, R/H should be less than 60%.
- G. Liquid in LCD is hazardous substance. Do not lick, swallow when the liquid is attached to your hands, skin, clothes etc. Wash it out thoroughly.